

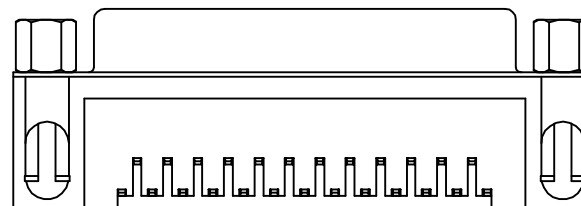
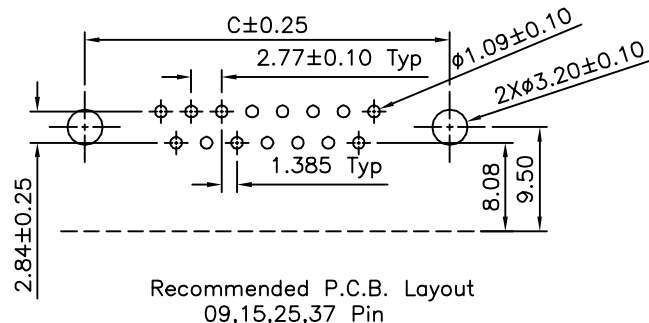
SPECIFICATION

△ Current Rating:1 Amp
 Withstanding Voltage:1000V(One Minute)
 Contact Resistance:20 Milliohms Max.
 Insulation Resistance:1000 Megaohms Min.
 At 500V DC
 Operation Temperature:-50°C~+105°C
 Insulator:PBT+30%G.F.(UL94V-0)
 Shell:SPCC,Nickel Plated
 Contact:Brass
 Boardlock:SPCC,Tin Plated
 Screw:12L14,Nickel Plated
 RoHS Compliant

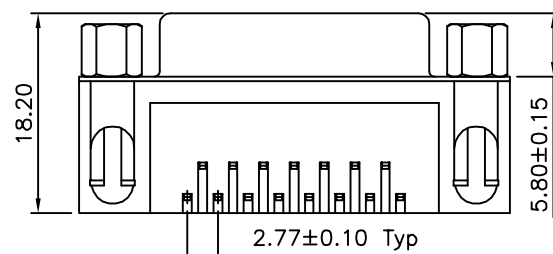
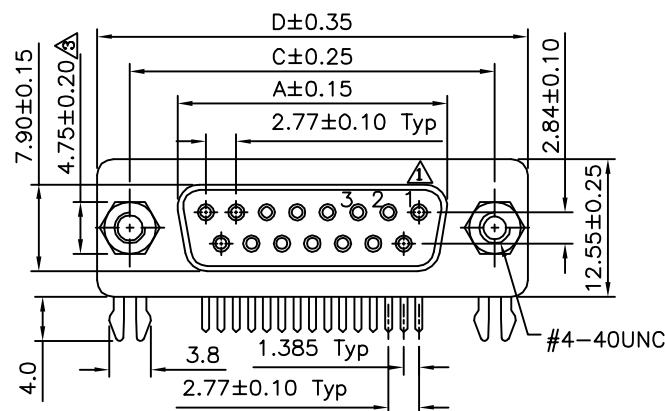
DR XX S - XX- SXX - H
 (1) (2) (3) (4) (5) (6)

- DR:D-SUB DIP Right Angle
- XX:No. Of Position
- S:Female Boardlock With 2 Jackscrew 4#40 Installed
- XX:Insulator Color
Blank:Black
BL:Blue
- SXX:Contact Finish
Blank:Gold Flash On Contact Area
Tin Plated On Solder Tails,Over Nickel
S15:Gold Plated 15u" On Contact Area
Tin Plated On Solder Tails,Over Nickel
S30:Gold Plated 30u" On Contact Area
Tin Plated On Solder Tails,Over Nickel
- H:RoHS Compliant

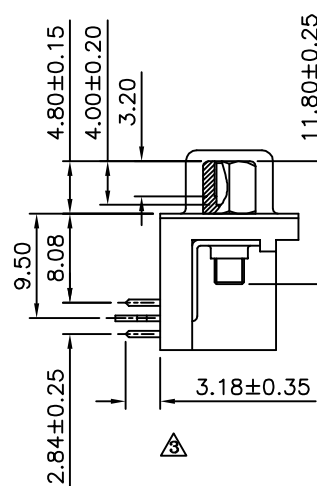
Pin	A	C	D
09	16.33	24.99	30.81
15	24.80	33.32	39.20
25	38.38	47.04	53.04
37	54.84	63.50	69.40



△ 25 Pin



△ 09,15,37 Pin



△

CATEGORY		APPROVED BY	
PART No.		MEI	
DRXXS-XX-SXX-H		CHECKED BY	
DRAWING No.		HZF	
DRXXS-XX-SXX-H		DRAWING BY	
SCALE		CYP	
NONE	REV.	C3	

UNLESS OTHERWISE SPECIFIED TOLERANCES ARE			
.X ±0.38	.X* ±3*		
.XX ±0.25	.XX* ±1*		
.XXX ±0.05	.XXX* ±0.5*		
UNIT	mm		

NO.	REV.	REVISIONS	CHK	DATE
△ C3		Modify Data	HZF	07/22/2015
△ C2		Modify Data	HZF	12/27/2013
△ C1		Modify Data	HZF	08/12/2013
△ C0		NEW RELEASE	HZF	05/24/2013